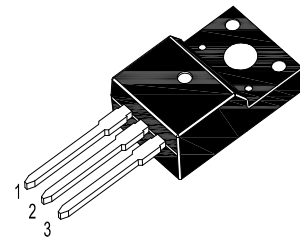
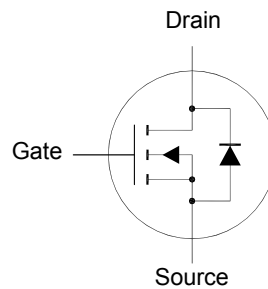


SFTN1180

N-Channel Enhancement Mode Power MOSFET



TO-220F Plastic Package
1.Gate 2.Drain 3.Source

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	800	V
Gate-Source Voltage	V_{GS}	± 20	V
Gate-Source Voltage AC($f > 1$ Hz)	V_{GS}	± 30	V
Drain Current	I_D	$T_C = 25^\circ\text{C}$ 11 $T_C = 100^\circ\text{C}$ 7.1	A
Peak Drain Current	I_{DM}	33	A
Power Dissipation	P_{tot}	41	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to + 150	$^\circ\text{C}$

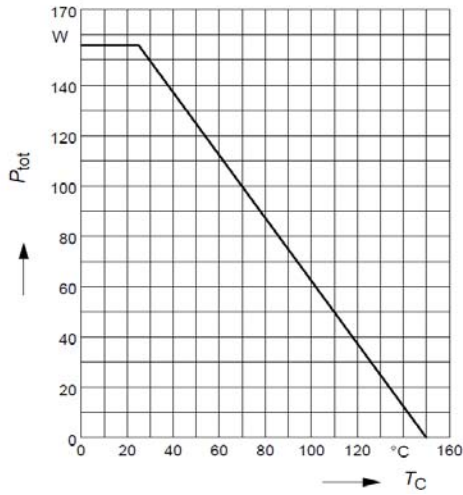
Thermal Characteristics

Parameter	Symbol	Max.	Unit
Maximum Thermal Resistance from Junction to Case	$R_{\theta JC}$	0.8	K/W
Maximum Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	62	K/W

SFTN1180

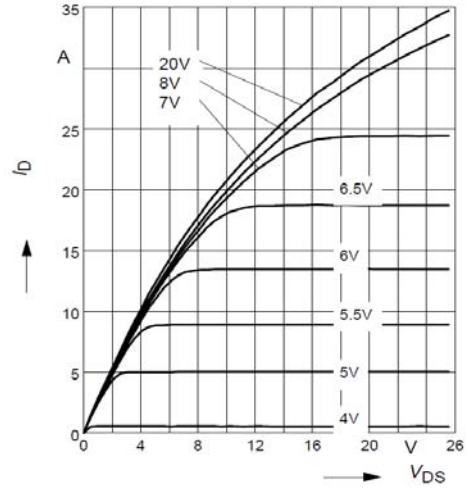
Characteristics at $T_J = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage at $I_D = 0.25\text{ mA}$	BV_{DSS}	800	-	-	V
Drain-Source Leakage Current at $V_{DS} = 800\text{ V}$ at $V_{DS} = 800\text{ V}$, $T_J = 150^\circ\text{C}$	I_{DSS}	- -	- -	20 200	μA
Gate Leakage Current at $V_{GS} = 20\text{ V}$	I_{GSS}	-	-	100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $I_D = 680\text{ }\mu\text{A}$	$V_{GS(th)}$	2.1	-	3.9	V
Drain-Source On-State Resistance at $V_{GS} = 10\text{ V}$, $I_D = 7.1\text{ A}$ at $V_{GS} = 10\text{ V}$, $I_D = 7.1\text{ A}$, $T_J = 150^\circ\text{C}$	$R_{DS(on)}$	- -	- 1.1	0.45 -	Ω
Forward Transconductance at $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$, $I_D = 7.1\text{ A}$	g_{FS}	-	7.5	-	S
Diode Forward Voltage at $I_S = I_F$, $V_{GS} = 0\text{ V}$	V_{SD}	-	-	1.2	V
Maximun Body-Diode Continuous Current	I_S	-	-	11	A
Input Capacitance at $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$	C_{iss}	-	1600	-	pF
Output Capacitance at $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$	C_{oss}	-	800	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0\text{ V}$, $V_{DS} = 25\text{ V}$, $f = 1\text{ MHz}$	C_{rss}	-	40	-	pF
Turn-On Delay Time at $I_D = 11\text{ A}$, $V_{DD} = 400\text{ V}$, $V_{GS} = 0/10\text{ V}$, $R_G = 7.5\text{ }\Omega$	$t_{d(on)}$	-	25	-	ns
Turn-On Rise Time at $I_D = 11\text{ A}$, $V_{DD} = 400\text{ V}$, $V_{GS} = 0/10\text{ V}$, $R_G = 7.5\text{ }\Omega$	t_r	-	15	-	ns
Turn-Off Delay Time at $I_D = 11\text{ A}$, $V_{DD} = 400\text{ V}$, $V_{GS} = 0/10\text{ V}$, $R_G = 7.5\text{ }\Omega$	$t_{d(off)}$	-	-	82	ns
Turn-Off Fall Time at $I_D = 11\text{ A}$, $V_{DD} = 400\text{ V}$, $V_{GS} = 0/10\text{ V}$, $R_G = 7.5\text{ }\Omega$	t_f	-	-	10	ns



Power dissipation

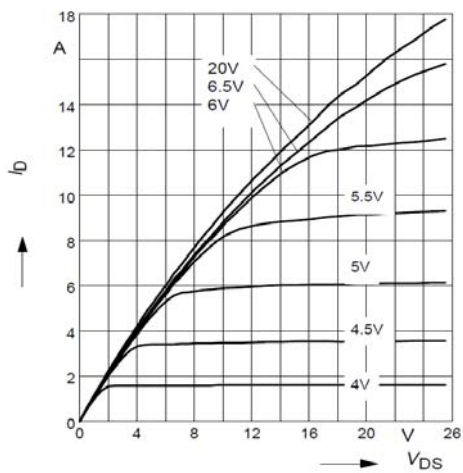
$P_{tot} = f(T_C)$



Typ. output characteristic

$I_D = f(V_{DS}); T_j = 25^\circ\text{C}$

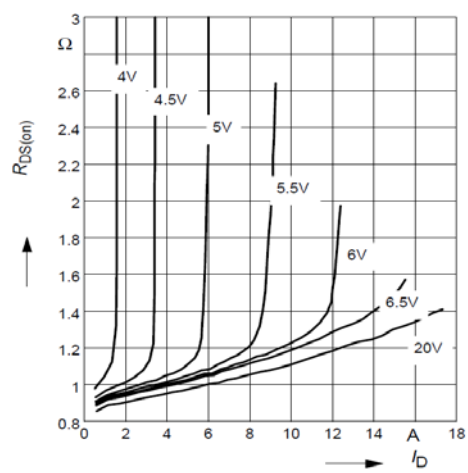
parameter: $t_p = 10 \mu\text{s}, V_{GS}$



Typ. output characteristic

$I_D = f(V_{DS}); T_j = 150^\circ\text{C}$

parameter: $t_p = 10 \mu\text{s}, V_{GS}$



Typ. drain-source on resistance

$R_{DS(on)} = f(I_D)$

parameter: $T_j = 150^\circ\text{C}, V_{GS}$

SFTN1180

TO-220F Package Outline

